

# BUL1203EFP

# HIGH VOLTAGE FAST-SWITCHING NPN POWER TRANSISTOR

- HIGH VOLTAGE CAPABILITY
- LOW SPREAD OF DYNAMIC PARAMETERS
- MINIMUM LOT-TO-LOT SPREAD FOR RELIABLE OPERATION
- VERY HIGH SWITCHING SPEED
- FULLY INSULATED PACKAGE (U.L. COMPLIANT) FOR EASY MOUNTING

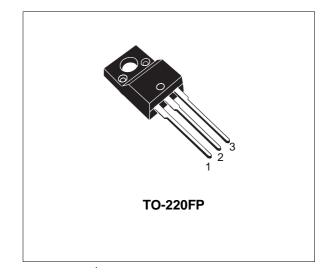
#### **APPLICATIONS**

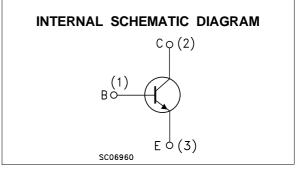
 ELECTRONIC BALLASTS FOR FLUORESCENT LIGHTING (277 V HALF BRIDGE AND 120 V PUSH-PULL TOPOLOGIES)

#### DESCRIPTION

The BUL1203EFP is a new device manufactured using Diffused Collector technology to enhance switching speeds and tight hFE range while maintaining a wide RBSOA.

Thanks to his structure it has an intrinsic ruggedness which enables the transistor to withstand a high collector current level during Breakdown condition, without using the transil protection usually necessary in typical converters for lamp ballast.





#### Symbol Parameter Value Unit V<sub>СВО</sub> Collector-BaseVoltage $(I_E = 0)$ 1200 V V Collector-Emitter Voltage ( $V_{BE} = 0$ ) 1200 VCES V Collector-Emitter Voltage $(I_B = 0)$ 550 Vceo Emitter-Base Voltage ( $I_c = 0$ ) V Vebo 9 **Collector Current** 5 А Ιc Ісм Collector Peak Current ( $t_p < 5 ms$ ) 8 А I<sub>B</sub> **Base Current** 2 A Base Peak Current ( $t_p < 5 \text{ ms}$ ) 4 A I<sub>BM</sub> Total Dissipation at T<sub>c</sub> = 25 °C 36 W Ptot Insulation Withstand Voltage (RMS) from All 1500 V Visol Three Leads to Exernal Heatsink °C Tsta Storage Temperature -65 to 150 °C Max. Operating Junction Temperature 150 Ti

#### ABSOLUTE MAXIMUM RATINGS

### THERMAL DATA

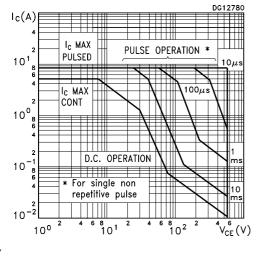
R <sub>thj-case</sub>	Thermal Resistance Junction-case	Max	3.47	°C/W
R <sub>thj-amb</sub>	Thermal Resistance Junction-ambient	Max	62.5	°C/W

## **ELECTRICAL CHARACTERISTICS** ( $T_{case} = 25 \ ^{\circ}C$ unless otherwise specified)

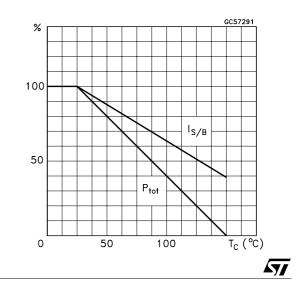
Symbol	Parameter	Test	Conditions	Min.	Тур.	Max.	Unit
ICES	Collector Cut-off Current (V <sub>BE</sub> = 0)	V <sub>CE</sub> = 1200 V				100	μA
I <sub>CEO</sub>	Collector Cut-off Current (I <sub>B</sub> = 0)	V <sub>CE</sub> = 550 V				100	μA
$V_{CEO(sus)}^*$	Collector-Emitter Sustaining Voltage (I <sub>B</sub> = 0)	I <sub>C</sub> = 100 mA	L = 25 mH	550			V
$V_{\text{EBO}}$	Emitter-Base Voltage (I <sub>C</sub> = 0)	I <sub>E</sub> = 10 mA		9			V
V <sub>CE(sat)</sub> *	Collector-Emitter Saturation Voltage	$I_{C} = 1 A$ $I_{C} = 2 A$ $I_{C} = 3 A$	$I_{B} = 0.2 A$ $I_{B} = 0.4 A$ $I_{B} = 1 A$			0.5 0.7 1.5	V V V
V <sub>BE(sat)</sub> *	Base-Emitter Saturation Voltage	$I_{C} = 2 A$ $I_{C} = 3 A$	I <sub>B</sub> = 0.4 A I <sub>B</sub> = 1 A			1.5 1.5	V V
h <sub>FE</sub> *	DC Current Gain	$I_{C} = 1 \text{ mA}$ $I_{C} = 10 \text{ mA}$ $I_{C} = 0.8 \text{ A}$ $I_{C} = 2 \text{ A}$	V <sub>CE</sub> = 5 V V <sub>CE</sub> = 5 V V <sub>CE</sub> = 3 V V <sub>CE</sub> = 5 V	10 10 14 9		32 28	
t <sub>on</sub> t <sub>s</sub> t <sub>f</sub>	RESISTIVE LOAD Turn-on Time Storage Time Fall Time	$I_{C} = 2 A$ $I_{B2} = -0.8 A$ $V_{CC} = 150 V$	$I_{B1} = 0.4 \text{ A}$ tp = 30 µs (see figure 2)		2.5 0.2	0.5 3.0 0.3	μs μs μs
Ear	Repetitive Avalanche Energy	L = 2 mH V <sub>CC</sub> = 50 V (see figure 3)	C = 1.8 nF V <sub>BE</sub> = -5 V	6			mJ

\* Pulsed: Pulse duration = 300 μs, duty cycle 1.5 %

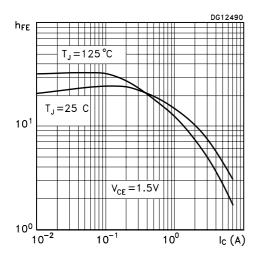
#### Safe Operating Area



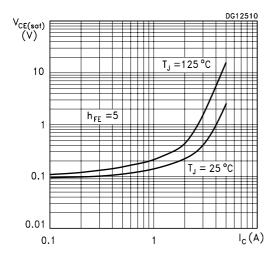
**Derating Curve** 

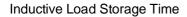


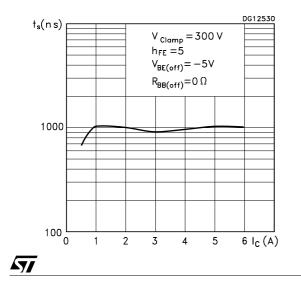
#### DC Current Gain



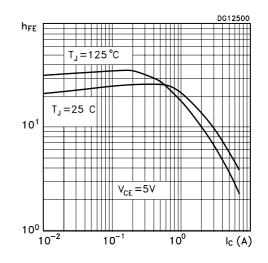
Collector-Emitter Saturation Voltage

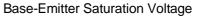


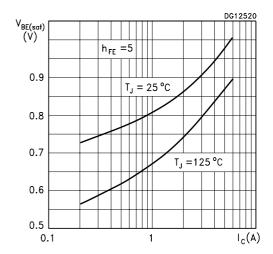


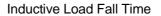


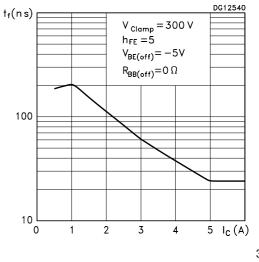
### DC Current Gain











Reverse Biased Safe Operating Area

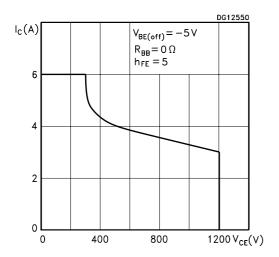


Figure 1: Inductive Load Switching Test Circuit

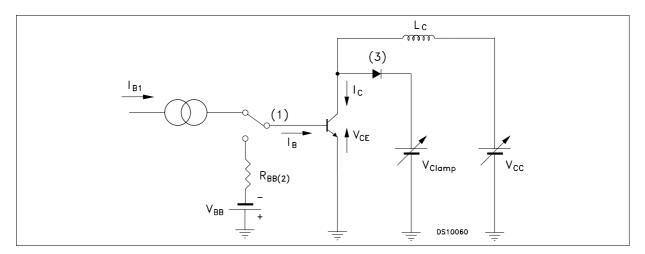
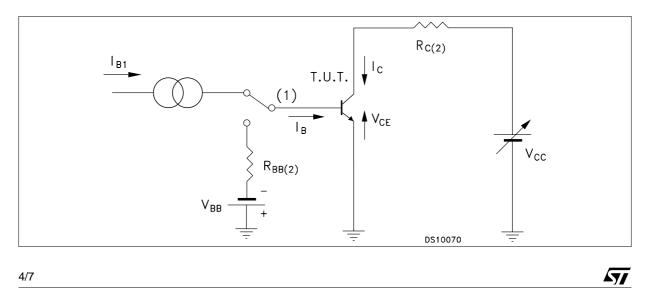
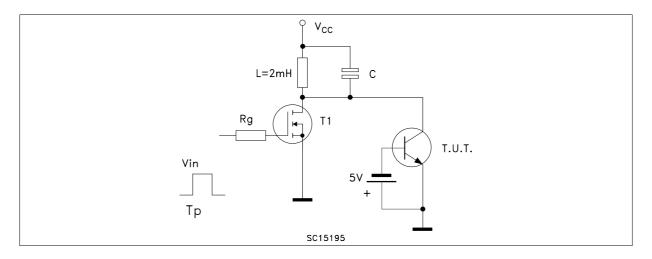


Figure 2: Resistive Load Switching Test Circuit

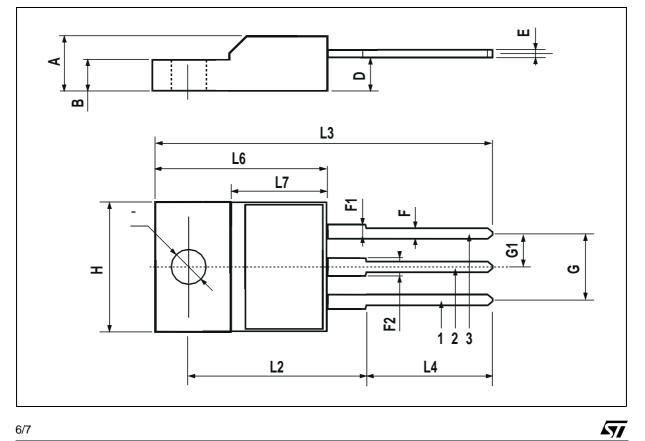


## Figure 3: Energy Rating Test Circuit



DIM.	mm			inch			
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
А	4.4		4.6	0.173		0.181	
В	2.5		2.7	0.098		0.106	
D	2.5		2.75	0.098		0.108	
Е	0.45		0.7	0.017		0.027	
F	0.75		1	0.030		0.039	
F1	1.15		1.7	0.045		0.067	
F2	1.15		1.7	0.045		0.067	
G	4.95		5.2	0.195		0.204	
G1	2.4		2.7	0.094		0.106	
Н	10		10.4	0.393		0.409	
L2		16			0.630		
L3	28.6		30.6	1.126		1.204	
L4	9.8		10.6	0.385		0.417	
L6	15.9		16.4	0.626		0.645	
L7	9		9.3	0.354		0.366	
L7 Ø	9 3		9.3 3.2	0.354 0.118			





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